



Update Notification

Document # : FPCN20649X1

Issue Date: 15 December 2015

Title of Change:	Update to FPCN20649 - exclude NSS30101LT1G & NSS30100LT1G from Copper Wire conversion		
Proposed first ship date:	15 December 2015		
Contact information:	Contact your local ON Semiconductor Sales Office or <Alex.Zhang@onsemi.com>		
Samples:	Contact your local ON Semiconductor Sales Office		
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or <S1016Z@onsemi.com>		
Type of notification:	ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <PCN.Support@onsemi.com>.		
Change category:	<input type="checkbox"/> Wafer Fab Change <input checked="" type="checkbox"/> Assembly Change <input type="checkbox"/> Test Change <input type="checkbox"/> Other _____		
Change Sub-Category(s):	<input type="checkbox"/> Manufacturing Site Change/Addition <input checked="" type="checkbox"/> Material Change <input type="checkbox"/> Datasheet/Product Doc change <input type="checkbox"/> Manufacturing Process Change <input type="checkbox"/> Product specific change <input type="checkbox"/> Shipping/Packaging/Marking <input type="checkbox"/> Other: _____		
Sites Affected:	<input type="checkbox"/> All site(s) <input type="checkbox"/> not applicable <input checked="" type="checkbox"/> ON Semiconductor site(s) : ON Leshan, China <input type="checkbox"/> External Foundry/Subcon site(s)		
Description and Purpose:	ON Semiconductor is notifying customer that NSS30101LT1G and NSS30100LT1G will be excluded and shall not undergo the Gold to Copper Wire conversion stated in FPCN20649.		
List of affected Standard Parts:	NSS30100LT1G NSS30101LT1G		